



Material Content Data Sheet



Sales Product Name		BTS50060-1TEA		Issued		25. September 2017			
MA#		MA001074018							
Package		PG-TO252-5-11		Weight*		356.59 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	4.311	1.21	1.21	12089	12089	
leadframe	non noble metal	iron	7439-89-6	0.205	0.06		574		
	inorganic material	phosphorus	7723-14-0	0.061	0.02		172		
	non noble metal	copper	7440-50-8	204.243	57.27	57.35	572769	573515	
wire	non noble metal	aluminium	7429-90-5	1.938	0.54	0.54	5436	5436	
encapsulation	organic material	carbon black	1333-86-4	1.378	0.39		3864		
	plastics	epoxy resin	-	24.110	6.76		67612		
	inorganic material	silicondioxide	60676-86-0	112.282	31.49	38.64	314877	386353	
leadfinish	non noble metal	tin	7440-31-5	5.072	1.42	1.42	14225	14225	
plating	non noble metal	nickel	7440-02-0	0.076	0.02		214		
	inorganic material	phosphorus	7723-14-0	0.000	0.00	0.02	1	215	
glue	plastics	Polyimide	26023-21-2	0.156	0.04	0.04	437	437	
solder	noble metal	silver	7440-22-4	0.069	0.02		193		
	non noble metal	tin	7440-31-5	0.055	0.02		155		
	non noble metal	lead	7439-92-1	2.632	0.74	0.78	7382	7730	
*deviation	< 10%					Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com